

Common-mode transient immunity for isolated gate drivers

By Shailendra Baranwal

Senior Design Engineer, Isolation Team

Introduction

Isolated gate drivers are widely used for driving insulated-gate bipolar transistors (IGBTs) and MOSFETs in various applications such as motor drives, solar inverters and automobiles. In addition to turning the IGBTs or MOSFETs on and off, these drivers provide galvanic isolation. The device's switching rate depends on the application and type of the device being used. Switching frequencies of 10 to 20 kHz are common in IGBTs, however, silicon carbide (SiC) and gallium-nitride or GaN-based systems can operate at 50 kHz to 200 kHz. Some advantages for using a higher switching frequency are smaller filter size, fast control and lower distortion. However, these advantages come with an increased power loss during transition. Common-mode transient immunity (CMTI) is an important parameter of a gate driver to consider when operating it at higher switching frequencies. This article gives background on a general pulse-width modulation (PWM) scheme, the transition loss associated with high switching frequency, and isolated gate-driver solutions to reduce transition time.

Typical inverter operation

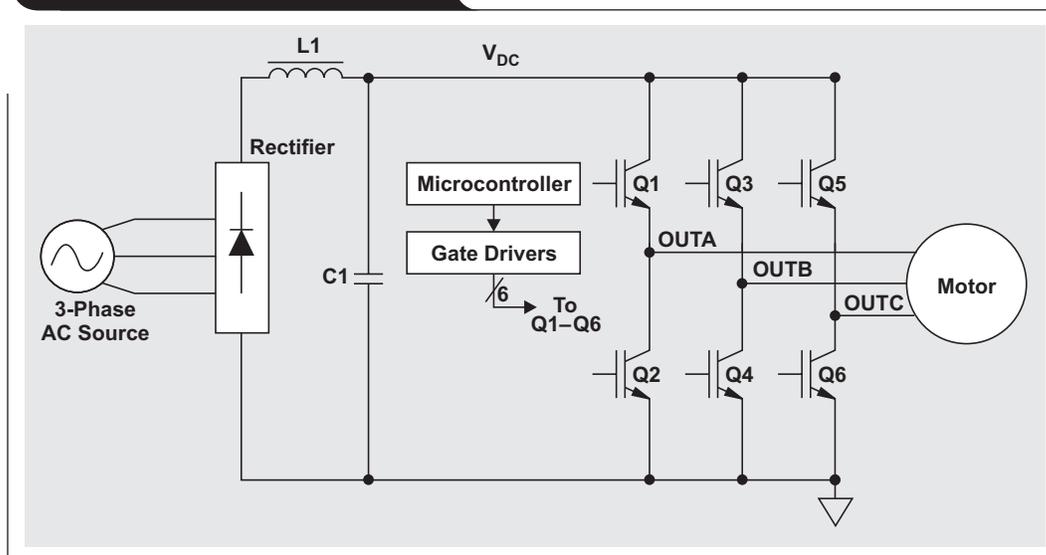
An inverter configuration is used for a DC-to-AC conversion. These voltage-source inverters (VSIs) can be used either for general AC voltage-output generation or motor control. Examples of AC voltage-output applications are

solar inverters, uninterruptable power supplies (UPSs), or AC applications powered from a battery in automobiles. The same inverter configuration allows for output-voltage amplitude and frequency control, which is more useful for a motor control. An induction-motor control is a common example of using an inverter for motor control.

Figure 1 contains a high-level diagram of an AC-to-DC and then DC-to-AC conversion. The system has a three-phase input and controllable three-phase AC output. The rectifier block converts the AC to DC, and a filter using L1 and C1 is used to filter out the residual ripple. A key parameter for the rectifier is its power factor. The simplest form of a rectifier uses diodes. Diode-based rectifiers have very poor power factor and are not suitable for high-power applications. Instead, rectifiers using active power factor correction (PFC) are preferred for high-power solutions.^[1]

The inverter consists mainly of Q1 through Q6 IGBTs and the gate-driver circuit. Input to the inverter is the DC supply (V_{DC}) produced by the rectifier. The purpose of the inverter is to convert DC to AC voltage. The frequency and amplitude of the inverter output is controlled by how the IGBTs are switched. In applications such as UPSs or solar inverters, a battery supplies power to the inverter. The load can be any general-purpose AC load, or it can connect to the grid. The fundamental structure of the inverter remains the same for many applications.

Figure 1. Motor control diagram



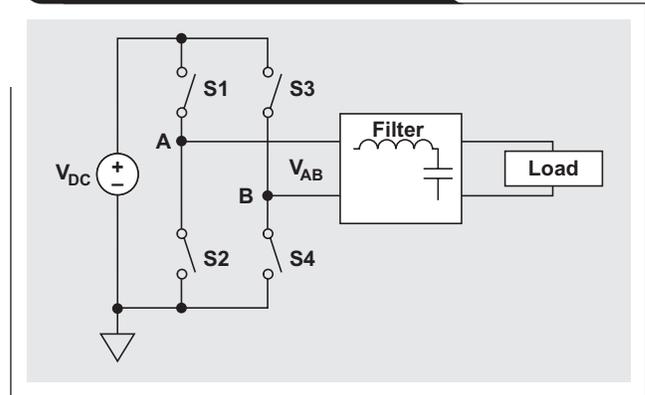
Battery-operated inverters are very common in electric vehicles. A microcontroller is used to produce a PWM waveform to drive the IGBTs and the outputs (OUTA, OUTB and OUTC) switch between 0 V and V_{DC} . An induction motor requires control of voltage and frequency to control its torque and speed. The microcontroller monitors the speed and current in the motor and provides the proper PWM pattern according to user inputs. IGBTs typically require gate drivers with isolated outputs because the output side is switching between 0 V and V_{DC} . The switching frequency of an IGBT-based inverter is typically in the range of 8 to 16 kHz and higher PWM switching frequencies are possible with SiC or GaN IGBTs.^[2, 3] In this scenario, gate drivers also need to support faster switching speeds. The inverter can be configured as a single-phase output with only two legs and four switches. Three-phase systems are typically used to get more power.

Pulse-width modulation

PWM or pulse-width modulation is a way to achieve amplitude control by changing the duty cycle.

Figure 2 shows a simple form of a single-phase inverter. Input to the inverter is a DC voltage (V_{DC}) and the voltage across the load is $V_{AB} = V_A - V_B$. The voltage at node A switches between V_{DC} and 0 V via switches S1 and S2. Similarly, the voltage at node B switches between V_{DC} and 0 V via switches S3 and S4. Switches S1 and S2 are complementary, as are switches S3 and S4. The maximum output voltage that can be achieved using this system is V_{DC} . An example of switching waveforms at nodes A and B without filtering is shown in Figure 3. The switching rate

Figure 2. High-level diagram of a single-phase inverter



can range from 10 to 200 kHz, depending on the application and type of switch. In Figure 3a, the duty cycle at node A is more than 50% and in Figure 3b, the duty cycle is less than 50% at node B. This creates a positive voltage across the load as shown in Figure 3c.

In Figure 3d, the duty cycle at node A is less than 50% and more than 50% at node B (Figure 3e), which creates a negative voltage across the load (Figure 3f).

The average voltage, V_{AB} , across the load/filter can be written as:

$$V_{AB} = V_{DC} \times D_A - V_{DC} \times D_B \text{ or } V_{AB} = V_{DC} \times (D_A - D_B) \quad (1)$$

where D_A is the duty cycle at node A, and D_B is duty cycle at node B.

Figure 3. Simplified PWM operation with positive and negative output voltages

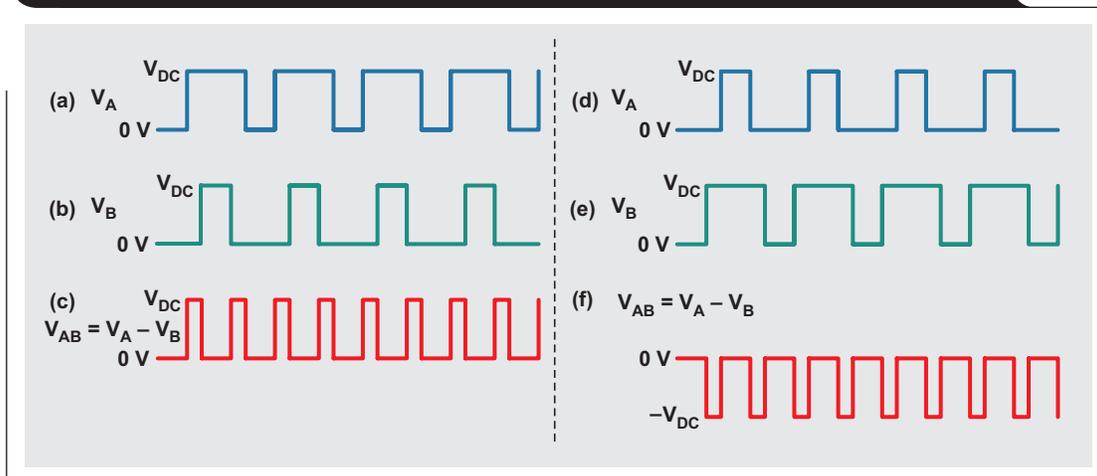
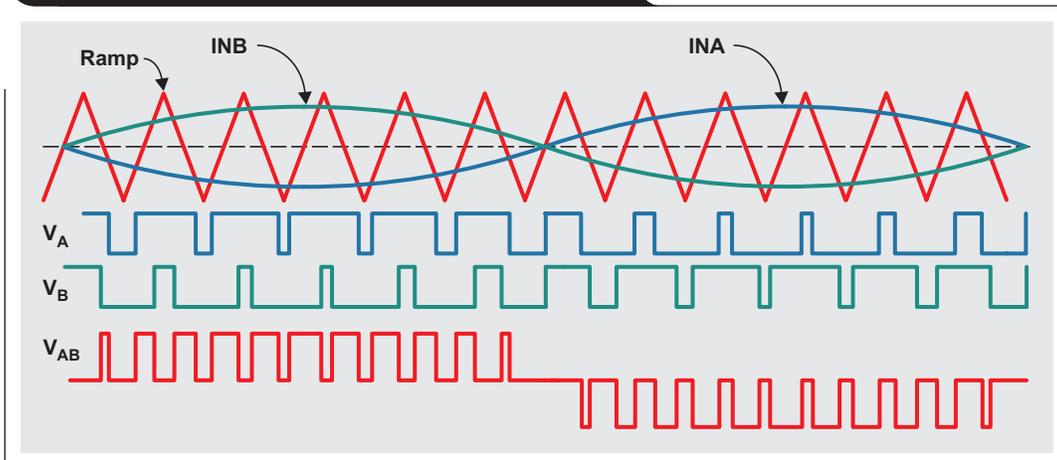


Figure 4. A single-phase PWM output waveform



Controlling the duty cycle, D_A and D_B , allows control of the output voltage, V_{AB} . A sinusoidal single-phase PWM waveform is obtained by comparing a reference sine wave INA and INB with a high-frequency triangular signal as shown in Figure 4.

The fundamental component of the output has an amplitude that is proportional to the differential reference input ($V_{INA} - V_{INB}$), and the frequency is the same as the reference frequency. This allows the voltage and frequency to be controlled by the reference signal. High-frequency tones are at frequencies $2nf_{SW} \pm mf_{IN}$, where f_{SW} is the triangular signal frequency, f_{IN} is the reference input frequency, and the n and m multipliers can be 1, 2, 3, etc. The high-frequency component is filtered by the LC filter, or the motor inductance in the case of motor control.

The ratio between the input signal amplitude and the triangular signal amplitude is called amplitude modulation ratio, or m_A .

$$m_A = \frac{V_{IN}}{V_{RAMP}} \tag{2}$$

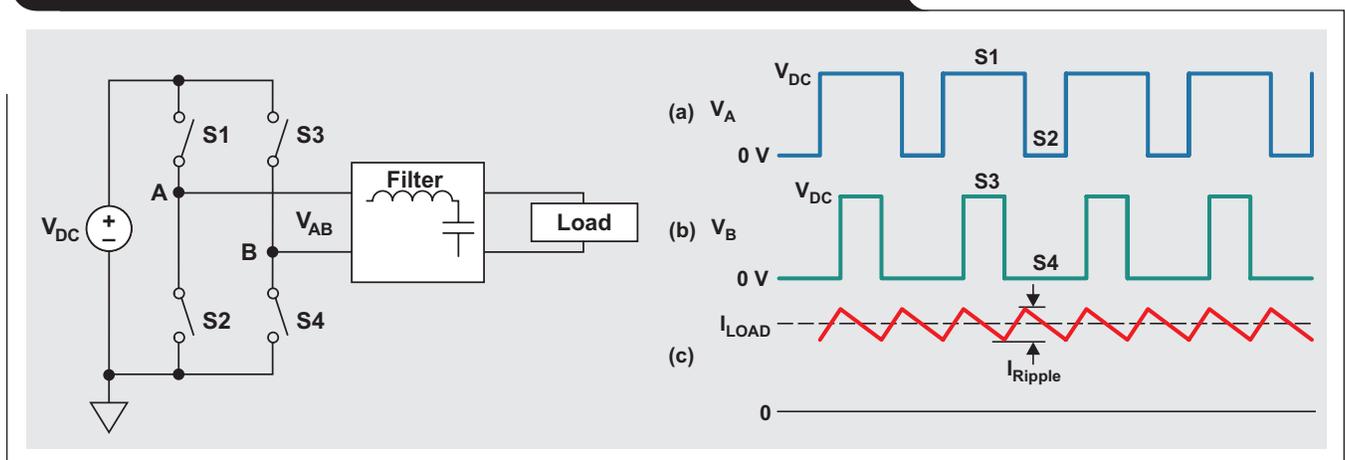
where V_{IN} is the amplitude of the reference input signal and V_{RAMP} is the amplitude of the triangular wave signal. The fundamental output voltage is $m_A \times V_{DC} \times \text{sine}(\omega t)$; where ω is the frequency of the reference input signal. The root mean square (rms) of the fundamental signal can be written as:

$$V_{RMS} = \frac{m_A \times V_{DC}}{\sqrt{2}} \tag{3}$$

Transition loss in inverters

The inverter outputs switch between ground and V_{DC} at the PWM frequency, however, the output current is filtered either by the LC filter or motor inductance. Figure 5 shows waveforms for voltage and current in a PWM switching output. Figure 5c shows a DC current with a very small ripple component. The ripple amplitude is dependent on the filter size. While this example shows a DC output, the same concept can be extended for a sine-wave output. However, the current is a sine wave with a small ripple riding on it.

Figure 5. An inverter's voltage and current waveforms with an LC filter



The instantaneous output power is $V_{AB} \times I_{LOAD}$, where V_{AB} is the average DC output, which is dependent on the duty cycles at nodes A and B. Assuming that there is no phase difference between the voltage and current, the output power for a sinusoidal output is:

$$P_{OUT} = V_{RMS} \times I_{RMS} = \frac{m_A \times V_{DC} \times I_{RMS}}{\sqrt{2}} \quad (4)$$

The transition time from 0 V to V_{DC} and vice versa of the voltage at node A is finite. The switch's ON impedance is very low when completely on, but higher during transition time. This leads to transition-switching losses. This loss occurs twice at every PWM cycle. Current through the switches during transition is same as the load current because it is filtered. Transition loss for a single event is $V_{DC} \times I_{LOAD} \times t_{RF} / 2$.

The total transition loss for a single-phase inverter is

$$P_{LOSS} = 2 \times 2 \times f_{SW} \times I_{LOAD} \times V_{DC} \times t_{RF} / 2$$

$$= 2 \times V_{DC} \times I_{LOAD} \times t_{RF} \times f_{SW},$$

where t_{RF} is the rise/fall time of the voltage. In case of a sinusoidal current output, current through the switches is an average of the load current:

$$|I_{LOAD}| = \frac{2\sqrt{2} \times I_{RMS}}{\pi} \quad (5)$$

and the power loss is:

$$P_{LOSS} = \frac{4\sqrt{2} \times V_{DC} \times I_{RMS} \times t_{RF} \times f_{SW}}{\pi} \quad (6)$$

Ratio of the loss to output power is:

$$\frac{P_{LOSS}}{P_{OUT}} = \frac{8 \times t_{RF} \times f_{SW}}{\pi \times m_A} \quad (7)$$

Equation 6 suggests that loss is proportional to the switching frequency. An inverter with a switching frequency of 16 kHz and 200-ns rise/fall time will have a 1% transition loss, assuming $m_A = 0.8$. To reduce the

transition loss, the rise/fall time has to be lower for a higher switching frequency. For example, a SiC-based inverter with a 64-kHz switching frequency needs a rise/fall time of 50 ns to keep a 1% transition loss.

Gate-drivers for Inverter

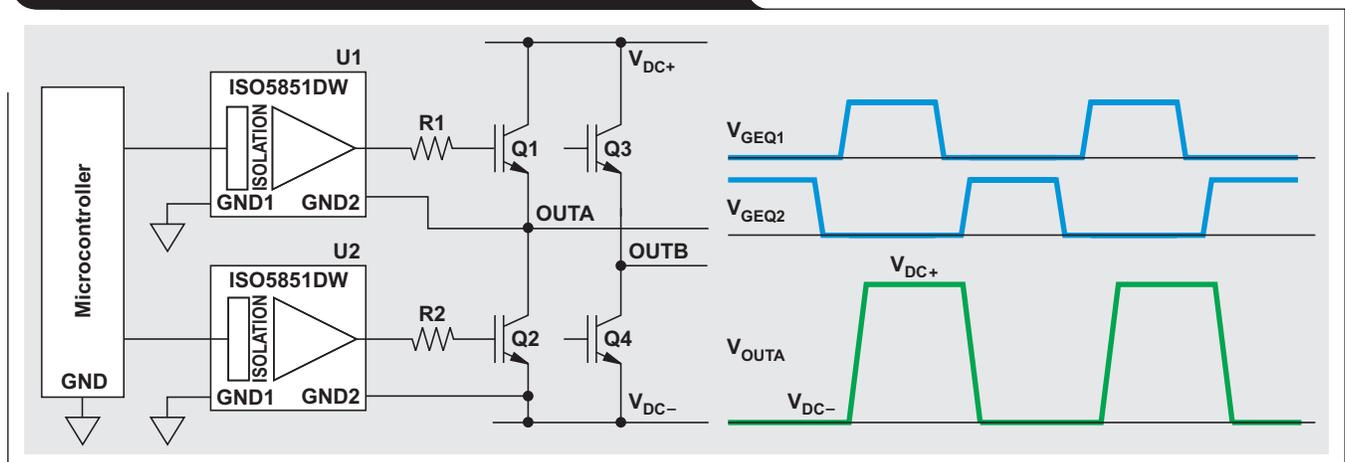
A typical drive of an IGBT-based, voltage-source inverter is shown in Figure 6. This figure shows a single-phase inverter, but it can be extended to a three-phase by adding one more leg of the bridge. The voltage at outputs OUTA or OUTB switches from V_{DC-} to V_{DC+} . The IGBT gate drives are isolated because the output-side ground of the driver is switching along with the inverter output while the input-side ground is fixed and connected to a chassis.

The potential differences between GND1 and GND2 of both gate drivers require the drivers to be isolated. The gate drivers support high-voltage isolation across the two grounds along with voltage transition rate at GND2. The gate drivers are also selected based on their isolation rating and their immunity to the transition on GND2, or common-mode transient immunity (CMTI). For example, if the DC bus is 1500 V and the transition time of OUTA is 100 ns, the immunity required by the gate driver is 15 V/ns. The immunity requirement for the driver increases if the rise/fall time is lower. A voltage-source inverter (VSI) with a higher switching frequency will have a higher CMTI requirement. A 1500-V VSI running at 64 kHz and 50-ns rise/fall time requires at least 30-V/ns CMTI. The CMTI requirement increases if the transition loss is to be lower.

The gate drivers are specified for CMTI in their data-sheet. For example, the ISO5851 and ISO5852S both have a minimum CMTI of 100 kV/μs. Higher CMTI for a gate driver ensures there is no false fault or false output toggle because of the transient noise.

The component placement or board design also matters for a robustness to transient noise. The parasitic capacitance between one side of the driver to the other side of the driver should be minimized. Using a diagram from the

Figure 6: Single-phase inverter with isolated gate drivers



ISO5851 datasheet, Figure 7 shows a typical application diagram. The Ready (RDY) and Fault (FLT) pins are pulled up by 10-kΩ resistors. These resistor values may need to be lower for noise immunity. Transient noise can generate a false fault or low under-voltage lockout (UVLO) signal. This issue can be solved by either reducing the resistor values or increasing the capacitance of C1 and C2.

Digital isolators such as the ISO7810, ISO7821 or ISO7841

also can be used in conjunction with SiC, GaN or IGBT drivers. Digital isolators provide reinforced isolation and a CMTI at a minimum of 100 kV/μs. Figure 8 shows an isolated driver solution using a digital isolator. The digital isolator can range from a single channel up to four channels, depending on the application. The digital isolator has an added benefit of low propagation delay, low skew and low jitter, which are useful in a high-frequency design.

Conclusion

Voltage-source inverters (VSIs) with PWM topology are a good choice for a motor control because the output amplitude and frequency control have a lot of flexibility. A higher switching frequency of PWM VSIs allows for a smaller filter size. The rise/fall times should be lower with high switching frequencies to keep the transition loss lower. A gate driver with good CMTI supports faster switching speeds. Gate-driver solutions from Texas Instruments can support a CMTI minimum of 100-kV/μs.

References

1. A. R. Prasad, P. D. Ziogas, and S. Manias, "An active power factor correction technique for three-phase diode rectifiers," *IEEE Trans. Power Electronics*, 1991 pp. 83-92
2. Dr Scott Allen, "Silicon Carbide MOSFETs for High Powered Modules," CREE Inc., March 19, 2013

Figure 7. Typical application where C1 and C2 can be changed to adjust CMTI

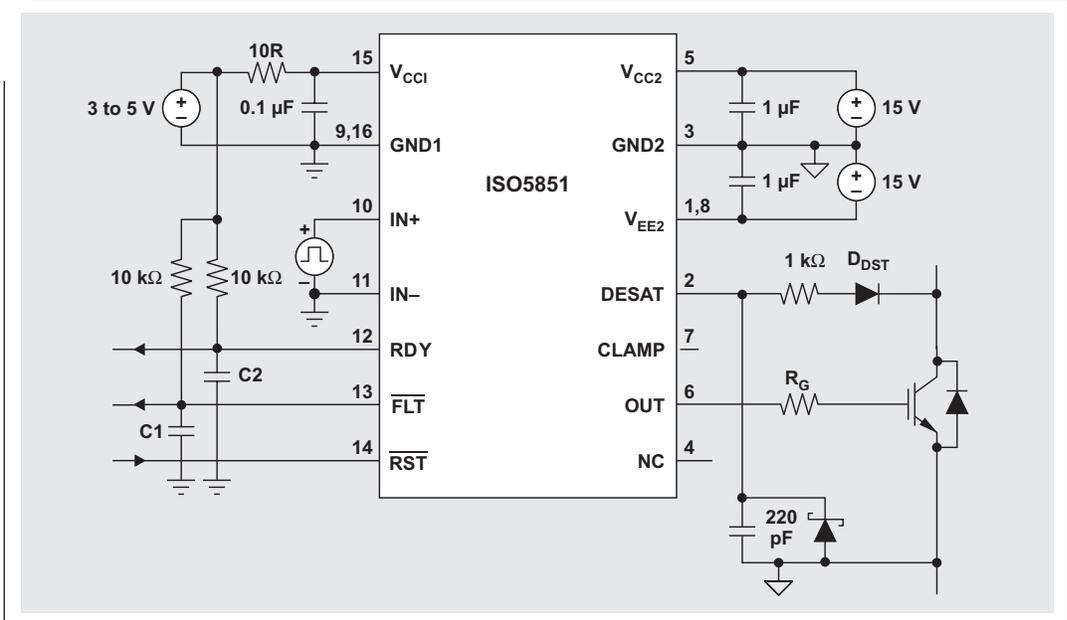
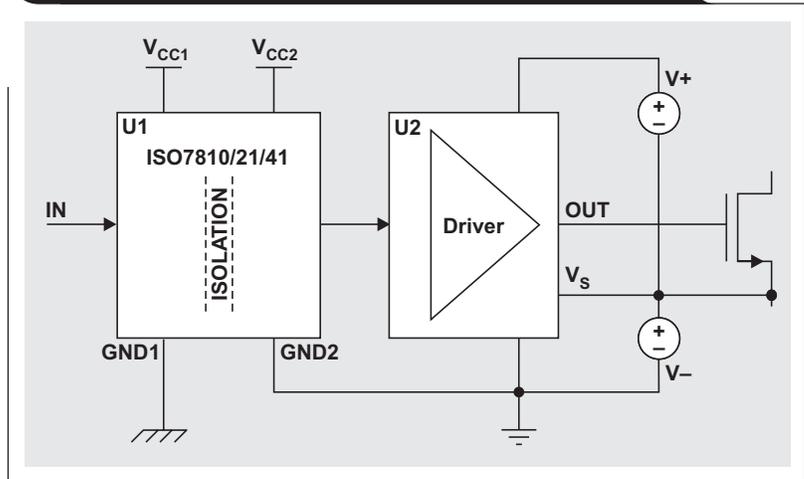


Figure 8. Gate-driver solution using digital isolators



3. Jang-Kwon Lim, D. Pefitsis, J. Rabkowski, M. Bakowski, H.-P. Nee, "Analysis and Experimental Verification of the Influence of Fabrication Process Tolerances and Circuit Parasitics on Transient Current Sharing of Parallel-Connected SiC JFETs," *Power Electronics, IEEE Transactions on*, Volume: 29, Issue: 5, May 2014, pp. 2180 – 2191

Related Web sites

Product information:
ISO5851, ISO5852S, ISO7810, ISO7821, ISO7841
 Subscribe to the AAJ:
www.ti.com/subscribe-aaaj

TI Worldwide Technical Support

Internet

TI Semiconductor Product Information Center Home Page

support.ti.com

TI E2E™ Community Home Page

e2e.ti.com

Product Information Centers

Americas	Phone	+1(512) 434-1560
Brazil	Phone	0800-891-2616
Mexico	Phone	0800-670-7544
	Fax	+1(972) 927-6377
	Internet/Email	support.ti.com/sc/pic/americas.htm

Europe, Middle East, and Africa

Phone		
European Free Call	00800-ASK-TEXAS (00800 275 83927)	
International	+49 (0) 8161 80 2121	
Russian Support	+7 (4) 95 98 10 701	

Note: The European Free Call (Toll Free) number is not active in all countries. If you have technical difficulty calling the free call number, please use the international number above.

Fax	+ (49) (0) 8161 80 2045
Internet	www.ti.com/asktexas
Direct Email	asktexas@ti.com

Japan

Fax	International	+81-3-3344-5317
	Domestic	0120-81-0036
Internet/Email	International	support.ti.com/sc/pic/japan.htm
	Domestic	www.tij.co.jp/pic

Asia

Phone	<u>Toll-Free Number</u>
Note: Toll-free numbers may not support mobile and IP phones.	
Australia	1-800-999-084
China	800-820-8682
Hong Kong	800-96-5941
India	000-800-100-8888
Indonesia	001-803-8861-1006
Korea	080-551-2804
Malaysia	1-800-80-3973
New Zealand	0800-446-934
Philippines	1-800-765-7404
Singapore	800-886-1028
Taiwan	0800-006800
Thailand	001-800-886-0010
International	+86-21-23073444
Fax	+86-21-23073686
Email	tiasia@ti.com or ti-china@ti.com
Internet	support.ti.com/sc/pic/asia.htm

Important Notice: The products and services of Texas Instruments Incorporated and its subsidiaries described herein are sold subject to TI's standard terms and conditions of sale. Customers are advised to obtain the most current and complete information about TI products and services before placing orders. TI assumes no liability for applications assistance, customer's applications or product designs, software performance, or infringement of patents. The publication of information regarding any other company's products or services does not constitute TI's approval, warranty or endorsement thereof.

A021014

IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, enhancements, improvements and other changes to its semiconductor products and services per JESD46, latest issue, and to discontinue any product or service per JESD48, latest issue. Buyers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All semiconductor products (also referred to herein as "components") are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its components to the specifications applicable at the time of sale, in accordance with the warranty in TI's terms and conditions of sale of semiconductor products. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by applicable law, testing of all parameters of each component is not necessarily performed.

TI assumes no liability for applications assistance or the design of Buyers' products. Buyers are responsible for their products and applications using TI components. To minimize the risks associated with Buyers' products and applications, Buyers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any patent right, copyright, mask work right, or other intellectual property right relating to any combination, machine, or process in which TI components or services are used. Information published by TI regarding third-party products or services does not constitute a license to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of significant portions of TI information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. TI is not responsible or liable for such altered documentation. Information of third parties may be subject to additional restrictions.

Resale of TI components or services with statements different from or beyond the parameters stated by TI for that component or service voids all express and any implied warranties for the associated TI component or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Buyer acknowledges and agrees that it is solely responsible for compliance with all legal, regulatory and safety-related requirements concerning its products, and any use of TI components in its applications, notwithstanding any applications-related information or support that may be provided by TI. Buyer represents and agrees that it has all the necessary expertise to create and implement safeguards which anticipate dangerous consequences of failures, monitor failures and their consequences, lessen the likelihood of failures that might cause harm and take appropriate remedial actions. Buyer will fully indemnify TI and its representatives against any damages arising out of the use of any TI components in safety-critical applications.

In some cases, TI components may be promoted specifically to facilitate safety-related applications. With such components, TI's goal is to help enable customers to design and create their own end-product solutions that meet applicable functional safety standards and requirements. Nonetheless, such components are subject to these terms.

No TI components are authorized for use in FDA Class III (or similar life-critical medical equipment) unless authorized officers of the parties have executed a special agreement specifically governing such use.

Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have **not** been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components as meeting ISO/TS16949 requirements, mainly for automotive use. In any case of use of non-designated products, TI will not be responsible for any failure to meet ISO/TS16949.

Products

Audio	www.ti.com/audio
Amplifiers	amplifier.ti.com
Data Converters	dataconverter.ti.com
DLP® Products	www.dlp.com
DSP	dsp.ti.com
Clocks and Timers	www.ti.com/clocks
Interface	interface.ti.com
Logic	logic.ti.com
Power Mgmt	power.ti.com
Microcontrollers	microcontroller.ti.com
RFID	www.ti-rfid.com
OMAP Applications Processors	www.ti.com/omap
Wireless Connectivity	www.ti.com/wirelessconnectivity

Applications

Automotive and Transportation	www.ti.com/automotive
Communications and Telecom	www.ti.com/communications
Computers and Peripherals	www.ti.com/computers
Consumer Electronics	www.ti.com/consumer-apps
Energy and Lighting	www.ti.com/energy
Industrial	www.ti.com/industrial
Medical	www.ti.com/medical
Security	www.ti.com/security
Space, Avionics and Defense	www.ti.com/space-avionics-defense
Video and Imaging	www.ti.com/video

TI E2E Community

e2e.ti.com